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符合 **Qi v1.2** 标准的 **bq5105xB** 高效无线电源接收器 和电池充电器

1 特性

- 单级无线电源接收器 和锂离子/锂聚合物电池充电器
	- 在单个小型封装内将无线电源接收器、整流器和 电池充电器组合在一起
	- 4.20V、4.35V 和 4.40V 输出电压选项
	- 支持高达 1.5A 的充电电流
	- 93% 峰值交流至直流 (AC-DC) 充电效率
- • 稳健耐用架构
	- 20V 最大输入电压容差,具有输入过压保护
	- 热关断及过流保护
	- 温度监控和故障检测
- 符合 WPC v1.2 Qi 行业标准
- 功率级输出跟踪整流器和电池电压以确保整个充电 周期内的最大效率
- • 采用小型 DSGBA 和 VQFN 封装
- **2** 应用
- 电池组
- 手机和智能电话
- • 耳机
- 便携式媒体播放器
- • 其他手持式器件

3 说明

Tools & **[Software](#page-33-0)**

bq5105x 器件是符合 Qi 标准的高效无线电源接收器, 具有集成的锂离子/锂聚合物电池充电控制器,可用于 便携式 应用。bq5105xB 器件提供高效交流/直流电源 转换,集成了符合 Qi v1.2 通信协议所需的数字控制 器,并提供了安全高效锂离子和锂聚合物电池充电所需 的所有必需控制算法。通过搭配使用 bq500212A 发送 器侧控制器,bq5105x 可为直接电池充电器解决方案 提供完整的无线电源传输系统。通过使用近场感应式电 力传输,嵌入在便携式器件内的接收器线圈能够接收发 送器线圈所发出的电能。来自接收器线圈的交流信号继 而被整流和调节以将电能直接应用到电池。为了稳定电 能传输过程,建立了接收器到发送器的全局反馈机制。 这个反馈使用 Qi v1.2 通信协议建立。

bq5105xB 器件在单个封装内集成了低阻抗同步整流 器、低压降稳压器 (LDO)、数字控制、充电器控制器 及精准电压和电流环路。整个功率级(整流器与 LDO)均使用低阻抗 N-MOSFET (100mΩ常用导通 电阻)以确保高效率与低功耗。

(1) 如需了解所有可用封装,请参阅数据表末尾的可订购产品附 录。

典型应用电路原理图

bq51050B, bq51051B, bq51052B

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注: 之前版本的页码可能与当前版本有所不同。

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• Changed Thermal shutdown name to TJ-SD for clarity .. [9](#page-8-0) • Added section to describe Adapter Enable function... [9](#page-8-1) • Changed Synchronous rectifer switchover name to IBAT-SR for clarity... [9](#page-8-2) • Added synchronous mode entry for bq51052B.. [9](#page-8-3) • Deleted note regarding internal junction monitor reducing current - it is not applicable. ... [19](#page-18-0) • Added section on modified JEITA profile for bq51052B... [21](#page-20-0) • Changed TS/CTRL function to correct Termination Packet value.. [22](#page-21-0) • Added Taper mode completion for Termination Packet... [22](#page-21-1) • Changed Beta value from 4500 to 3380 to match NTC datasheet .. [25](#page-24-1) • Changed received power maximum error from 250 mW to 375 mW to comply with latest WPC v1.2 specification........... [27](#page-26-1)

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5 Device Options

6 Pin Configuration and Functions

The exposed thermal pad should be connected to ground.

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Pin Functions

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7 Specifications

7.1 Absolute Maximum Ratings(1)(2)

over operating free-air temperature range (unless otherwise noted)

(1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions* is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) All voltages are with respect to the VSS terminal, unless otherwise noted.

7.2 ESD Ratings

(1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

(2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

7.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

7.4 Thermal Information

(1) For more information about traditional and new thermal metrics, see the *[Semiconductor](http://www.ti.com/cn/lit/pdf/SPRA953) and IC Package Thermal Metrics* application report.

Thermal Information (continued)

7.5 Electrical Characteristics

Over junction temperature range $0^{\circ}C \leq T_J \leq 125^{\circ}C$ and recommended supply voltage (unless otherwise noted)

(1) $V_{RECT-REG}$ is overridden when rectifier foldback mode is active $(V_{RECT-REG}-V_{TRACK})$.

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TEXAS

Electrical Characteristics (continued)

Over junction temperature range $0^{\circ}C \leq T_J \leq 125^{\circ}C$ and recommended supply voltage (unless otherwise noted)

Electrical Characteristics (continued)

Over junction temperature range $0^{\circ}C \leq T_J \leq 125^{\circ}C$ and recommended supply voltage (unless otherwise noted)

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7.6 Typical Characteristics

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Typical Characteristics (continued)

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Typical Characteristics (continued)

8 Detailed Description

8.1 Overview

8.1.1 A Brief Description of the Wireless System

A wireless system consists of a charging pad (primary, transmitter) and the secondary-side equipment. There are coils in the charging pad and in the secondary equipment which magnetically couple to each other when the equipment is placed on the charging pad. Power is transferred from the primary to the secondary by transformer action between the coils. Control over the amount of power transferred is achieved by changing the frequency of the primary drive.

The secondary can communicate with the primary by changing the load seen by the primary. This load variation results in a change in the primary coil current, which is measured and interpreted by a processor in the charging pad. The communication is digital - packets are transferred from the secondary to the primary. Differential biphase encoding is used for the packets. The rate is 2-kbps.

Various types of communication packets have been defined. These include identification and authentication packets, error packets, control packets, power usage packets, end of power packet and efficiency packets.

The primary coil is powered off most of the time. It wakes up occasionally to see if a secondary is present. If a secondary authenticates itself to the primary, the primary remains powered up. The secondary maintains full control over the power transfer using communication packets.

Figure 19. WPC Wireless Power Charging System Indicating the Functional Integration of the bq5105x

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Texas

8.2 Functional Block Diagram

8.3 Feature Description

8.3.1 Using the bq5105x as a Wireless Li-Ion/Li-Pol Battery Charger (With Reference to *[Functional](#page-13-0) Block [Diagram](#page-13-0)***)**

[Functional](#page-13-0) Block Diagram is the schematic of a system which uses the bq5105x as a direct battery charger. When the system shown in *[Functional](#page-13-0) Block Diagram* is placed on the charging pad (transmitter), the receiver coil couples to the magnetic flux generated by the coil in the charging pad which consequently induces a voltage in the receiver coil. The internal synchronous rectifier feeds this voltage to the RECT pin which has the filter capacitor C_3 .

The bq5105x identifies and authenticates itself to the primary using the COMM pins by switching on and off the COMM FETs and hence switching in and out C_{COMM} . If the authentication is successful, the transmitter will remain powered on. The bq5105x measures the voltage at the RECT pin, calculates the difference between the actual voltage and the desired voltage $V_{RECT-REG}$ and sends back error packets to the primary. This process goes on until the RECT voltage settles at $V_{RECT-REG}$.

During power-up, the LDO is held off until the $V_{\text{RECT-REG}}$ threshold converges. The voltage control loop ensures that the output (BAT) voltage is maintained at $V_{BAT-REG}$. The values of V_{BAT} and V_{RECT} are dependant on the battery charge mode. The bq5105x continues to monitor the V_{RECT} and V_{BAT} and sends error packets to the primary every 250 ms. The bq5105x regulates the V_{RECT} voltage very close to battery voltage, this voltage tracking process minimizes the voltage difference across the internal LDO and maximizes the charging efficiency. If a large transient occurs, the feedback to the primary speeds up to every 32 ms in order to converge on an operating point in less time.

8.3.2 Details of a Qi Wireless Power System and bq5105xB Power Transfer Flow Diagrams

The bq5105xB integrates a fully compliant WPC v1.2 communication algorithm in order to streamline receiver designs (no extra software development required). Other unique algorithms such as Dynamic Rectifier Control are also integrated to provide best-in-class system performance. This section provides a high level overview of these features by illustrating the wireless power transfer flow diagram from start-up to active operation.

During start-up operation, the wireless power receiver must comply with proper handshaking to be granted a power contract from the TX. The TX will initiate the handshake by providing an extended digital ping. If an RX is present on the TX surface, the RX will then provide the signal strength, configuration and identification packets to the TX (see volume 1 of the WPC specification for details on each packet). These are the first three packets sent to the TX. The only exception is if there is a shutdown condition on the EN1/EN2, AD, or TS/CTRL pins where the Rx will shut down the TX immediately. Once the TX has successfully received the signal strength, configuration and identification packets, the RX will be granted a power contract and is then allowed to control the operating point of the power transfer. With the use of the bq5105xB Dynamic Rectifier Control algorithm, the RX will inform the TX to adjust the rectifier voltage above 5 V before enabling the output supply. This method enhances the transient performance during system start-up. See [Figure](#page-15-0) 20 for the start-up flow diagram details.

EXAS ISTRUMENTS

Feature Description (continued)

Once the start-up procedure has been established, the RX will enter the active power transfer stage. This is considered the "main loop" of operation. The Dynamic Rectifier Control algorithm will determine the rectifier voltage target based on a percentage of the maximum output current level setting (set by K_{IUM} and the $I_{\text{II IM}}$ resistance to PGND). The RX will send control error packets in order to converge on these targets. As the output current changes, the rectifier voltage target will dynamically change. As a note, the feedback loop of the WPC system is relatively slow where it can take up to 90 ms to converge on a new rectifier voltage target. It should be understood that the instantaneous transient response of the system is open loop and dependent on the RX coil output impedance at that operating point. More details on this will be covered in the section Receiver Coil Load-Line Analysis. The "main loop" will also determine if any conditions are true and will then discontinue the power transfer. [Figure](#page-16-0) 21 shows the active power transfer loop.

Figure 21. Active Power Transfer Flow Diagram

8.3.3 Battery Charge Profile

The battery is charged in three phases: precharge, fast-charge constant current and constant voltage. A voltagebased battery pack thermistor monitoring input (TS function of the TS/CTRL pin) is included that monitors battery temperature for safe charging. The TS function for bq51050B and bq51051B is JEITA compatible. The TS function for the bq51052B modifies the current regulation differently than standard JEITA. See *[Battery-Charger](#page-20-3) Safety and JEITA [Guidelines](#page-20-3)* for more details.

The rectifier voltage follows BAT voltage plus V_{TRACK} for any battery voltage above V_{LOWV} to full regulation voltage and most of the taper charging phase. If the battery voltage is below V_{LOWV} the rectifier voltage increases to $V_{RECT-REG}$.

If I_{BAT} is less than $I_{EndTrack}$ (a percentage of I_{BULK}) during taper mode, the rectifier voltage increases to $V_{RECT-REG}$.

The charge profile for the bq51050B and bq51051B is shown in [Figure](#page-18-2) 23 while the bq51052B is shown in [Figure](#page-18-3) 24.

Figure 23. bq51050B and bq51051B Li-Ion Battery Charge Profile

Figure 24. bq51052B Li-Ion Battery Charge Profile

8.3.4 Battery Charging Process

8.3.4.1 *Precharge Mode* $(V_{BAT} \le V_{LOWV})$

The bq5105X enters precharge mode when $V_{BAT} \le V_{LOW}$. Upon entering precharge mode, battery charge current limit is set to I_{PRECHG}. During precharge mode, the charge current is regulated to K_{PRECHG} percent of the fast charge current (I_{BULK}) setting. For example, if IBULK is set to 800 mA, then the precharge current would have a typical value of 160 mA.

If the battery is deeply discharged or shorted (V_{BAT} < $V_{BAT(SC)}$), the bq5105X applies $I_{BAT(SC)}$ current to bring the battery voltage up to acceptable charging levels. Once the battery rises above $V_{BAT(SC)}$, the charge current is regulated to I_{PRECHG} .

Under normal conditions, the time spent in this precharge region is a very short percentage of the total charging time and this does not affect the overall charging efficiency for very long.

8.3.4.2 Fast Charge Mode / Constant Voltage Mode

Once V_{BAT} > V_{LOWV} , the bq5105x enters fast charge mode (Current Regulation Phase) where charge current is regulated using the internal MOSFETs between RECT and BAT. Once the battery voltage charges up to V_{BAT} . $_{\text{REG}}$, the bq5105x enters constant voltage (CV) phase and regulates battery voltage to V_{OREG} and the charging current is reduced.

Once I_{BAT} falls below the termination threshold ($I_{TERM-Tn}$), the charger sends an EPT (Charge Complete) notification to the TX and enters high impedance mode.

8.3.4.3 Battery Charge Current Setting Calculations

8.3.4.3.1 RILIM Calculations

The bq5105x includes a means of providing hardware overcurrent protection by means of an analog current regulation loop. The hardware current limit provides an extra level of safety by clamping the maximum allowable output current (for example, a current compliance). The calculation for the total R_{ILM} resistance is as follows:

$$
R_1 = \frac{K_{\text{ILIM}}}{I_{\text{BULK}}} - R_{\text{FOD}} \qquad R_{\text{ILIM}} = R_1 + R_{\text{FOD}} \qquad I_{\text{BULK}} = \frac{K_{\text{ILIM}}}{R_{\text{ILIM}}} \qquad (1)
$$

Where I_{BULK} is the programmed battery charge current during fast charge mode. When referring to the application diagram shown in [Figure](#page-27-3) 32, ${\sf R}_{\sf ILM}$ is the sum of ${\sf R}_{\sf FOD}$ and ${\sf R}_{\sf 1}$ (the total resistance from the ILIM pin to PGND).

8.3.4.3.2 Termination Calculations

The bq5105X includes a programmable upper termination threshold. The upper termination threshold is calculated using [Equation](#page-19-1) 2:

$$
R_{\text{TERM}} = K_{\text{TERM}} \cdot \frac{1}{2} \cdot \frac
$$

$$
\mathcal{E}_{\text{BULK}} = \frac{R_{\text{TERM}}}{K_{\text{TERM}}}
$$

The K_{TERM} constant is specified in *Electrical [Characteristics](#page-6-0)* as 240 Ω/%. The upper termination threshold is set as a percentage of the charge current setting (I_{BULK}) .

For example, if R_{ILIM} is set to 314 Ω, I_{BULK} will be 1 A (314 ÷ 314). If the upper termination threshold is desired to be 100 mA, this would be 10% of I_{BULK}. The R_{TERM} resistor would then equal 2.4 kΩ (240 × 10).

Termination can be disabled by floating the TERM pin. If the TERM pin is grounded the termination function is effectively disabled. However, due to offsets of internal comparators, termination may occur at low battery currents.

8.3.4.4 Battery-Charger Safety and JEITA Guidelines

The bq5105x continuously monitors battery temperature by measuring the voltage between the TS/CTRL pin and PGND. A negative temperature coefficient thermistor (NTC) and an external voltage divider typically develop this voltage. The bq5105x compares this voltage against its internal thresholds to determine if charging is allowed. To initiate a charge cycle, the voltage on TS/CTRL pin (V_{TS}) must be within the V_{T1} to V_{T4} thresholds. If V_{TS} is outside of this range, the bq5105x suspends charge and waits until the battery temperature is within the V_{T1} to VT4 range. Additional information on the Temperature Sense function can be found in *Internal [Temperature](#page-23-1) Sense (TS Function of the [TS/CTRL](#page-23-1) Pin)*.

8.3.4.4.1 bq51050B and bq51051B JEITA

If V_{TS} is within the ranges of V_{T1} and V_{T2} or V_{T3} and V_{T4} , the charge current is reduced to $I_{BULK}/2$. If V_{TS} is within the range of V_{T1} and V_{T3}, the maximum charge voltage regulation is V_{OREG}. If V_{TS} is within the range of V_{T3} and V_{T4} , the maximum charge voltage regulation is reduced to "NEW SPEC". [Figure](#page-20-1) 25 summarizes the operation.

Figure 25. JEITA Compatible TS Profile for bq51050B and bq51051B

8.3.4.4.2 bq51052B Modified JEITA

The bq51052B has a modififed JEITA profile. The maximum charge current is not modified between V_{T1} and V_{T2} or between V_{T3} and V_{T4} , it remains at I_{BULK} . The maximum charge voltage is reduced to V_{O-J} when the V_{TS} is between V_{T3} and V_{T4} .

Figure 26. JEITA Compatible TS Profile for bq51052B

8.3.4.5 Input Overvoltage

If, for some condition (for example, a change in position of the equipment on the charging pad), the rectifier voltage suddenly increases in potential, the voltage-control loop inside the bq5105x becomes active, and prevents the output from going beyond $V_{BAT-REG}$. The receiver then starts sending back error packets every 32 ms until the RECT voltage comes back to an acceptable level, and then maintains the error communication every 250 ms.

If the input voltage increases in potential beyond V_{OVP} , the device switches off the internal FET and communicates to the primary to bring the voltage back to $V_{RECT-REG}$. In addition a proprietary voltage protection circuit is activated by means of C_{CLAMP1} and C_{CLAMP2} that protects the device from voltages beyond the maximum rating.

8.3.4.6 End Power Transfer Packet (WPC Header 0x02)

The WPC allows for a special command to terminate power transfer from the TX termed End Power Transfer (EPT) packet. WPC v1.2 specifies the reasons for sending a termination packet and their data field value. In [Table](#page-21-2) 1, the CONDITION column corresponds to the stimulus causing the bq5105x device to send the hexidecimal code in the VALUE column.

8.3.4.7 Status Output

The bq5105x provides one status output, CHG. This output is an open-drain NMOS device that is rated to 20 V. The open-drain FET connected to the CHG pin will be turned on whenever the output (BAT) of the charger is enabled. As a note, the output of the charger supply will not be enabled if the $V_{RFCT-REG}$ does not converge to the no-load target voltage.

8.3.4.8 Communication Modulator

The bq5105x provides two identical, integrated communication FETs which are connected to the pins COMM1 and COMM2. These FETs are used for modulating the secondary load current which allows bq5105x to communicate error control and configuration information to the transmitter.There are two methods to implement load modulation, capacitive and resistive.

Capacitive load modulation is more commonly used. Capacitive load modulation is shown in [Figure](#page-22-1) 27. In this case, a capacitor is connected from COMM1 to AC1 and from COMM2 to AC2. When the COMM switches are closed there is effectively a 22 nF capacitor connected between AC1 and AC2. Connecting a capacitor in between AC1 and AC2 modulates the impedance seen by the coil, which will be reflected to the primary and interpreted by the controller as a change in current.

Figure 27. Capacitive Load Modulation

[Figure](#page-22-2) 28 shows how the COMM pins can be used for resistive load modulation. Each COMM pin can handle at most a 24 Ω communication resistor. Therefore, if a COMM resistor between 12 Ω and 24 Ω is required, COMM1 and COMM2 pins must be connected in parallel. bq5105x does not support a COMM resistor less than 12 Ω .

Figure 28. Resistive Load Modulation

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8.3.4.9 Adaptive Communication Limit

The Qi communication channel is established through backscatter modulation as described in the previous sections. This type of modulation takes advantage of the loosely coupled inductor relationship between the RX and TX coils. Essentially, the switching in-and-out of the communication capacitor or resistor adds a transient load to the RX coil in order to modulate the TX coil voltage and current waveform (amplitude modulation). The consequence of this technique is that a load transient (load current noise) from the mobile device has the same signature. To provide noise immunity to the communication channel, the output load transients must be isolated from the RX coil. The proprietary feature *Adaptive Communication Limit* achieves this by dynamically adjusting the current limit of the regulator.

This can be seen in [Figure](#page-10-0) 12. In this plot, an output load is limited to 400 mA during communications time. The pulses on V_{RECT} indicate that a communication packet event is occurring. The regulator limits the load to a constant 400 mA and, therefore, preserves communication.

8.3.4.10 Synchronous Rectification

The bq5105x provides an integrated, self-driven synchronous rectifier that enables high-efficiency AC to DC power conversion. The rectifier consists of an all NMOS H-Bridge driver where the back gates of the diodes are configured to be the rectifier when the synchronous rectifier is disabled. During the initial start-up of the WPC system the synchronous rectifier is not enabled. At this operating point, the DC rectifier voltage is provided by the diode rectifier. Once V_{RECT} is greater than V_{UVLO} , half synchronous mode will be enabled until the load current surpasses I_{BAT-SR} . Above I_{BAT-SR} the full synchronous rectifier stays enabled until the load current drops back below the hysteresis level $(I_{BAT-SRH})$ where half synchronous mode is re-enabled.

8.3.4.11 Internal Temperature Sense (TS Function of the TS/CTRL Pin)

The bq5105x includes a ratiometric battery temperature sense circuit. The temperature sense circuit has two ratiometric thresholds which represent hot and cold conditions. An external temperature sensor is recommended to provide safe operating conditions to the receiver product. This pin is best used when monitoring the battery temperature.

The circuits in [Figure](#page-23-2) 29 allow for any NTC resistor to be used with the given V_{HOT} and V_{COLD} thresholds. The thermister characteristics and threshold temperatures selected will determine which circuit is best for an application.

Figure 29. NTC Circuit Options for Safe Operation of the Wireless Receiver Power Supply

(3)

(4)

The resistors R1 and R3 can be solved by resolving the system of equations at the desired temperature thresholds. The two equations are:

$$
\%V_{COLD} = \frac{\left(\frac{R_3 (R_{NTC}|_{TCOLD} + R_1)}{R_3 + (R_{NTC}|_{TCOLD} + R_1)}\right)}{\left(\frac{R_3 (R_{NTC}|_{TCOLD} + R_1)}{R_3 + (R_{NTC}|_{TCOLD} + R_1)}\right) + R_2} \times 100
$$

$$
\%V_{HOT} = \frac{\left(\frac{R_3 (R_{NTC}|_{THOT} + R_1)}{R_3 + (R_{NTC}|_{THOT} + R_1)}\right)}{\left(\frac{R_3 (R_{NTC}|_{THOT} + R_1)}{R_3 + (R_{NTC}|_{THOT} + R_1)}\right) + R_2} \times 100
$$

Where:

$$
R_{\text{NTC}}|_{\text{TCOLD}} = R_{o}e^{\beta(\sqrt{\text{TCOLD}} - \sqrt{\text{TO}})} \\
R_{\text{NTC}}|_{\text{THOT}} = R_{o}e^{\beta(\sqrt{\text{THOT}} - \sqrt{\text{TO}})}\n\tag{7}
$$

 $T_{\texttt{COLD}}$ and $T_{\texttt{HOT}}$ are the desired temperature thresholds in degrees Kelvin. $\mathsf{R_o}$ is the nominal resistance at $\mathsf{T_0}$ (25°C) and β is the temperature coefficient of the NTC resistor. For an example solution for part number ERT-JZEG103JA see the *[BQ5105XB](http://www.ti.com/product/BQ51051B/toolssoftware) NTC Calculator Tool*, (SLUS629).

Where,

 $T_{\text{COLD}} = 0^{\circ}C (273.15^{\circ}K)$ T_{HOT} = 60°C (333.15°K) $β = 3380$ $R_o = 10 k\Omega$

The plot of the percent V_{TSB} versus temperature is shown in [Figure](#page-25-0) 30:

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Figure 30. Example Solution for Panasonic Part # ERT-JZEG103JA

[Figure](#page-25-1) 31 shows the periodic biasing scheme used for measuring the TS state. An internal TS_READ signal enables the TS bias voltage for 25 ms. During this period the TS comparators are read (each comparator has a 10-ms deglitch) and appropriate action is taken based on the temperature measurement. After this 25-ms period has elapsed the TS_READ signal goes low, which causes the TS/CTRL pin to become high impedance. During the next 100-ms period, the TS voltage is monitored and compared to $V_{\text{CTRL-HI}}$. If the TS voltage is greater than $V_{\text{CTRL-HI}}$ then a secondary device is driving the TS/CTRL pin and a CTRL = 1 is detected.

Figure 31. Timing Diagram for TS Detection Circuit

8.3.4.11.1 TS/CTRL Function

The TS/CTRL pin offers three functions:

- NTC temperature monitoring
- Charge done indication
- **Fault indication**

When an NTC resistor is connected between the TS/CTRL pin and PGND, the NTC function is allowed to operate. This functionality can effectively be disabled by connecting a 10 kΩ resistor from TS/CRTL to PGND. If the TS/CTRL pin is pulled above V_{CTRL-HI}, the RX is shut down with the indication of a charge complete condition. If the TS/CTRL pin is pulled below V $_{\sf CTRL\text{-}LOW}$, the RX is shut down with the indication of a fault.

8.3.4.11.2 Thermal Protection

The bq5105x includes thermal shutdown protection. If the die temperature reaches T_{J-SD} , the LDO is shut off to prevent any further power dissipation. Once the temperature falls T_{J-Hys} below T_{J-SD} , operation can continue.

8.3.4.12 WPC v1.2 Compatibility

The bq5105x is a WPC v1.2 compatible device. In order to enable a Power Transmitter to monitor the power loss across the interface as one of the possible methods to limit the temperature rise of Foreign Objects, the bq5105x reports its Received Power to the Power Transmitter. The Received Power equals the power that is available from the output of the Power Receiver plus any power that is lost in producing that output power. For example, the power loss includes (but is not limited to) the power loss in the Secondary Coil and series resonant capacitor, the power loss in the Shielding of the Power Receiver, the power loss in the rectifier, the power loss in any postregulation stage, and the eddy current loss in metal components or contacts within the Power Receiver. In the WPC v1.2 specification, foreign object detection (FOD) is enforced, that means the bq5105x will send received power information with known accuracy to the transmitter.

WPC v1.2 defines Received Power as "the average amount of power that the Power Receiver receives through its Interface Surface, in the time window indicated in the Configuration Packet".

A Receiver will be certified as WPC v1.2 only after meeting the following requirement. The device under test (DUT) is tested on a Reference Transmitter whose transmitted power is calibrated, the receiver must send a received power such that:

 $0 <$ (TX PWR) REF – (RX PWR out) DUT < 375 mW

This 250 mW bias ensures that system will remain interoperable.

WPC v1.2 Transmitters will be tested to see if they can detect reference Foreign Objects with a Reference receiver. The WPC v1.2 specification allows much more accurate sensing of Foreign Objects than WPC v1.0.

A Transmitter can be certified as a WPC v1.2 only after meeting the following requirement. A Transmitter is tested to see if it can prevent some reference Foreign Objects (disc, coin, foil) from exceeding their threshold temperature (60°C, 80°C).

8.4 Device Functional Modes

The general modes of battery charging are described above in the *Feature [Description](#page-13-1)*. The bq5105x devices have several functional modes. Start-up refers to the initial power transfer and communication between the receiver (bq5105x circuit) and the transmitter. Power transfer refers to any time that the TX and RX are communicating and power is being delivered from the TX to the RX. Charge termination covers intentional termination (charge complete) and unintentional termination (removal of the RX from the TX, over temperature or other fault conditions).

9 Application and Implementation

NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

9.1 Application Information

The bq51050B is an integrated wireless power receiver and charger in a single device. The device complies with the WPC v1.2 specifications for a wireless power receiver. When paired with a WPC v1.2 compliant transmitter, it can provide up to 5-W of power for battery charging. There are several tools available for the design of the system. These tools may be obtained by checking the product page at [www.ti.com/product/bq51050b.](http://www.ti.com/product/bq51050b)

9.2 Typical Application

9.2.1 bq51050B Used as a Wireless Power Receiver and Li-Ion/Li-Pol Battery Charger

The following application discussion covers the requirements for setting up the bq51050B in a Qi-compliant system for charging a battery.

Figure 32. Typical Application Schematic

9.2.1.1 Design Requirements

This application is for a 4.2-V Lithium-Ion battery to be charged at 800 mA. Because this is planned for a WPC v1.2 solution, any of the Qi-certified transmitters can be used interchangeably so no discussion of the TX is required. To charge a 4.20-V Li-Ion battery, the bq51050B will be chosen. Each of the components from the application drawing will be examined. Temperature sensing of the battery must be done with JEITA specifications. An LED indicator is required to notify the user if charging is active.

Typical Application (continued)

9.2.1.2 Detailed Design Procedure

9.2.1.2.1 Series and Parallel Resonant Capacitor Selection

Shown in [Figure](#page-28-2) 33, the capacitors C1 (series) and C2 (parallel) make up the dual resonant circuit with the receiver coil. These two capacitors must be sized correctly per the WPC v1.2 specification. [Figure](#page-28-2) 33 shows the equivalent circuit of the dual resonant circuit:

Figure 33. Dual Resonant Circuit with the Receiver Coil

The power receiver design requirements in volume 1 of the WPC v1.2 specification highlights in detail the sizing requirements. To summarize, the receiver designer will be required take inductance measurements with a fixed test fixture. The test fixture is shown in [Figure](#page-28-3) 34:

Primary Shielding

Figure 34. WPC v1.2 Receiver Coil Test Fixture for the Inductance Measurement Ls'

The primary shield is to be 50 mm \times 50 mm \times 1 mm of Ferrite material PC44 from TDK Corp. The gap (dZ) is to be 3.4 mm. The receiver coil, as it will be placed in the final system (for example, the back cover and battery must be included if the system calls for this), is to be placed on top of this surface and the inductance is to be measured at 1-V RMS and a frequency of 100 kHz. This measurement is termed Ls'. The measurement termed Ls is the free-space inductance. Each capacitor can then be calculated using [Equation](#page-28-0) 6:

$$
C_1 = \frac{1}{(2\pi \times f s)^2 \times L_s'}
$$

$$
C_2 = \left((f_D \times 2\pi)^2 \times L_s - \frac{1}{C_1} \right)^{-1}
$$

(6)

Where f_S is 100 kHz +5/–10% and f_D is 1 MHz ±10%. ${\sf C}_1$ must be chosen first prior to calculating ${\sf C}_2$. The quality factor must be greater than 77 and can be determined by [Equation](#page-29-0) 7:

(7)

Typical Application (continued)

$$
Q = \frac{2\pi \times f_D \times LS}{R}
$$

Where R is the DC resistance of the receiver coil. All other constants are defined above.

For this application, we will design with an inductance measurement (L) of 11 µH and an Ls' of 16 µH with a DC resistance of 191 mΩ. Plugging Ls' into [Equation](#page-28-0) 6 above, we get a value for C₁ to be 158.3 nF. The range on the capacitance is about 144 nF to 175 nF. To build the resulting value, the optimum solution is usually found with 3 capacitors in parallel. This allows for more precise selection of values, lower effective resistance and better thermal results. To get 158 nF, choose from standard values. In this case, the values are 68 nF, 47 nF and 39 nF for a total of 154 nF. Well in the required range. Now that C_1 is chosen, the value of C_2 can be calculated. The result of this calculation is 2.3 nF. The practical solution for this is 2 capacitors, a 2.2 nF capacitor and a 100 pF capacitor. In all cases, these capacitors must have at least a 25-V rating. Solving for the quality factor (Q) this solution shows a rating over 500.

9.2.1.2.2 COMM, CLAMP and BOOT Capacitors

For most applications, the COMM, CLAMP and BOOT capacitors will be chosen to match the Evaluation Module.

The BOOT capacitors are used to allow the internal rectifier FETs to turn on and off properly. These capacitors are on the AC1 or AC2 lines to the Boot nodes and should have a minimum of 10-V rating. A 10-nF capacitor with a 10-V rating is chosen.

The CLAMP capacitors are used to aid the clamping process to protect against overvoltage. Choosing a 0.47-µF capacitor with a 25-V rating is appropriate for most applications.

The COMM capacitors are used to facilitate the communication from the RX to the TX. This selection can vary a bit more than the BOOT and CLAMP capacitors. In general, a 22-nF capacitor is recommended. Based on the results of testing of the communication robustness, a change to a 47-nF capacitor may be in order. The larger the capacitor the larger the deviation will be on the coil which sends a stronger signal to the TX. This also decreases the efficiency somewhat. In this case, choose the 22-nF capacitor with the 25-V rating.

9.2.1.2.3 Charging and Termination Current

The *Design [Requirements](#page-27-4)* show an 800-mA charging current and an 80-mA termination current.

Setting the charge current (I_{BULK}) is done by selecting the R₁ and R_{FOD}. Solving [Equation](#page-19-2) 1 results in R_{ILIM} of 393 $Ω$. Setting R_{FOD} to 200 Ω as a starting point before the FOD calibration is recommended. This leaves 205 Ω for R_1 . Using standard resistor values (or resistors in series / parallel) can improve accuracy.

Setting the termination current is done with [Equation](#page-19-1) 2. Because 80 mA is 10% of the I_{BULK} (800mA), the R_{TERM} is calculated as (240 $*$ 10) or 2.4 kΩ.

9.2.1.2.4 Adapter Enable

The AD pin will be tied to the external USB power source to allow for an external source to power the system. AD_EN is tied to the gate of Q1 (CSD75205W1015). This allows the bq51050B to sense when power is applied to the AD pin. The EN2 pin controls whether the wired source will be enabled or not. EN2 is tied to the system host to allow it to control the use of the USB power. If wired power is enabled and present, the AD pin will disable the BAT output and then enable Q1 through the AD_EN pin. An external charger is required to take control of the battery charging.

9.2.1.2.5 Charge Indication and Power Capacitors

The CHG pin is open-drain. D₁ and R₄ are selected as a 2.1-V forward bias capable of 2 mA and a 100- Ω current-limiting resistor.

RECT is used to smooth the internal AC to DC conversion. Two 10-µF capacitors and a 0.1-µF capacitor are chosen. The rating is 25 V.

BAT capacitors are 1.0 μ F and 0.1 μ F.

Typical Application (continued)

9.2.1.3 Application Curves

Typical Application (continued)

9.2.2 Application for Wired Charging

The application discussed below will cover the same requirements as the first example and will add a DC supply with a secondary charger. This solution covers using a standard DC supply or a USB port as the supply.

Figure 37. bq51050B Wireless Power Receiver and Wired Charger

9.2.2.1 Design Requirements

The requirements for this solution are identical to the first application so all common components are identical. This solution adds a wired charger and a blocking back-back FET (Q1).

The addition of a wired charger is simply enabled. The AD pin on the bq5105x is tied to the input of the DC supply. When the bq5105x senses a voltage greater than $V_{AD\text{-Pres}}$ on the AD pin, the BAT pin will be disabled (high impedance). Once the BAT pin is disabled, the AD_EN pin will transition and enable Q1. If wireless power is not present, the functionality of AD and AD \overline{ED} remains and wired charging can take place.

9.2.2.2 Detailed Design Procedure

9.2.2.2.1 Blocking Back-Back FET

Q1 is recommended to eliminate the potential for both wired and wireless systems to drive current to the simultaneously. The charge current and DC voltage level will set up parmerters for the blocking FET. The requirements for this system are 1 A for the wired charger and 5 V DC. The CSD75207W15 is chosen for its low RON and small size.

The wired charger in this solution is the bq24040. See the bq24040 datasheet ([SLUS941](http://www.ti.com/cn/lit/pdf/SLUS941)) for specific component selection.

10 Power Supply Recommendations

The bq51050B requires a Qi-compatible transmitter as its power supply.

11 Layout

11.1 Layout Guidelines

- Keep the trace resistance as low as possible on AC1, AC2, and BAT.
- Detection and resonant capacitors need to be as close to the device as possible.
- COMM, CLAMP, and BOOT capacitors need to be placed as close to the device as possible.
- Via interconnect on PGND net is critical for appropriate signal integrity and proper thermal performance.
- High frequency bypass capacitors need to be placed close to RECT and OUT pins.
- ILIM and FOD resistors are important signal paths and the loops in those paths to PGND must be minimized.
- For the RHL package, connect the thermal pad to ground to help dissipate heat.

Signal and sensing traces are the most sensitive to noise; the sensing signal amplitudes are usually measured in mV, which is comparable to the noise amplitude. Make sure that these traces are not being interfered by the noisy and power traces. AC1, AC2, BOOT1, BOOT2, COMM1, and COMM2 are the main source of noise in the board. These traces should be shielded from other components in the board. It is usually preferred to have a ground copper area placed underneath these traces to provide additional shielding. Also, make sure they do not interfere with the signal and sensing traces. The PCB should have a ground plane (return) connected directly to the return of all components through vias (two vias per capacitor for power-stage capacitors, one via per capacitor for small-signal components).

For a 1-A fast charge current application, the current rating for each net is as follows:

- $AC1 = AC2 = 1.2 A$
- $OUT = 1 A$
- $RECT = 100$ mA (RMS)
- $COMMx = 300$ mA
- $CLAMPx = 500 mA$
- All others can be rated for 10 mA or less

11.2 Layout Example

Figure 38. bq5105x Layout Example

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12 器件和文档支持

12.1 文档支持

12.1.1 相关文档

相关文档如下:

《具有自动启动功能的 *bq2404x 1A* 单输入单节锂离子和锂聚合物电池充电器》,[SLUS941](http://www.ti.com/cn/lit/pdf/SLUS941)

12.2 相关链接

下面的表格列出了快速访问链接。类别包括技术文档、支持与社区资源、工具和软件,以及申请样片或购买产品的 快速链接。

表 **2.** 相关链接

12.3 接收文档更新通知

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这些装置包含有限的内置 ESD 保护。 存储或装卸时, 应将导线一起截短或将装置放置于导电泡棉中, 以防止 MOS 门极遭受静电损 像 伤。

12.7 Glossary

[SLYZ022](http://www.ti.com/cn/lit/pdf/SLYZ022) — *TI Glossary*.

This glossary lists and explains terms, acronyms, and definitions.

13 机械、封装和可订购信息

以下页面包括机械、封装和可订购信息。这些信息是指定器件的最新可用数据。这些数据发生变化时,我们可能不 会另行通知或修订此文档。如欲获取此产品说明书的浏览器版本,请参见左侧的导航栏。

PACKAGING INFORMATION

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

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(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

PACKAGE OPTION ADDENDUM

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⁽⁵⁾ Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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TEXAS

TAPE AND REEL INFORMATION

ISTRUMENTS

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE

PACKAGE MATERIALS INFORMATION

www.ti.com 25-Sep-2024

RHL 20

3.5 x 4.5 mm, 0.5 mm pitch

GENERIC PACKAGE VIEW

VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD

Images above are just a representation of the package family, actual package may vary. Refer to the product data sheet for package details.

4205346/L

PACKAGE OUTLINE

VQFN - 1 mm max height RHL0020A

PLASTIC QUAD FLATPACK- NO LEAD

-
- per ASME Y14.5M.
This drawing is subject to change without notice.
-

EXAMPLE BOARD LAYOUT

RHL0020A VQFN - 1 mm max height

PLASTIC QUAD FLATPACK- NO LEAD

NOTES: (continued)

-
-
- locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.

EXAMPLE STENCIL DESIGN RHL0020A VQFN - 1 mm max height

PLASTIC QUAD FLATPACK- NO LEAD

NOTES: (continued)

7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations..

YFP (R-XBGA-N28)

DIE-SIZE BALL GRID ARRAY

All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994. A.

B. This drawing is subject to change without notice.

C. NanoFree™ package configuration.

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